

TUSB2136 Universal Serial Bus Compound Hub with General Purpose 8052 MCU

Data Manual



August 2007

MSDS Bus Solutions

SLLS442E

TUSB2136 Data Manual

Universal Serial Bus Compound Hub with General-Purpose 8052 MCU

Literature Number: SLLS442E August 2007







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1 Introduction

The TUSB2136 is an integrated universal serial bus (USB) hub with a general-purpose 8052 microcontroller that can be used for various USB controller applications. The TUSB2136 has $8K \times 8$ RAM space for application development. Using a 12-MHz crystal, the onboard oscillator generates the internal system clocks. No additional programming is required for any part of the hub functions. The device is programmed via an inter-IC (I²C) serial interface at power on from an EEPROM, or optionally, the application firmware can be downloaded from a host PC via USB. The 8052-based microprocessor allows several third-party standard tools to be used for application development. In addition, the application code available in the general market can also be used (this may or may not require some code modification due to hardware variations).

1.1 Features

- Multiproduct support with one code and one chip (up to 16 products with one chip)
- Fully compliant with the USB specification as a compound full-speed device: TID #30270119
- Supports 1.5- and 12-Mbits/s USB data rates
- Supports USB suspend/resume and remote wake-up operation
- Integrated two-port hub with individual power management per port
- Integrated 8052 microcontroller with:
 - 256 \times 8 RAM for internal data
 - 8K × 8 RAM code space available for downloadable firmware from host or I²C port.
 - 512 × 8 shared RAM used for data buffers and endpoint descriptor blocks (EDB) [1]
 - Four 8052 GPIO ports (ports 0,1, 2 and 3)
 - Master I²C controller for external slave device access
 - Watchdog timer
- Operates from a 12-MHz crystal
- On-chip PLL generates 48 MHz
- Supports a total of three input and three output (interrupt, bulk) endpoints
- Power-down mode
- 64-pin TQFP package

1.2 Functional Block Diagram

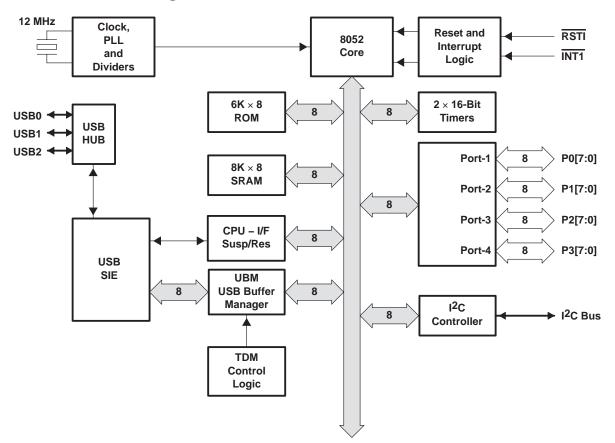
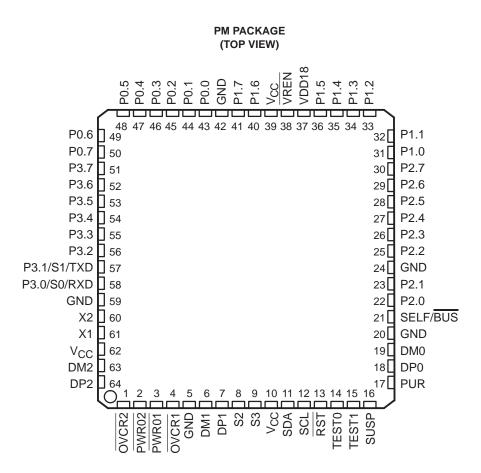


Figure 1–1. TUSB2136 Block Diagram

1.3 Terminal Assignments



1.4 Ordering Information

	PACKAGE
T _A	PLASTIC QUAD FLATPACK (PM)
0°C to 70°C	TUSB2136PM

1.5 Terminal Functions

TERMINAL NAME NO.			DESCRIPTION				
		1/0	DESCRIPTION				
DM0	19	I/O	Differential data-minus USB port 0: upstream				
DM1	6	I/O	Differential data-minus port 1: downstream				
DM2	63	I/O	Differential data-minus port 2: downstream				
DP0	18	I/O	Differential data-plus USB port 0: upstream				
DP1	7	I/O	Differential data-plus port 1: downstream				
DP2	64	I/O	Differential data-plus port 2: downstream				
GND	5, 20, 24, 42, 59	—	Power supply ground				
OVCR1	4	Ι	Port 1: Overcorrect indicator; Schmitt-trigger input, 100-µA active pullup				
OVCR2	1	Ι	Port 2: Overcorrect indicator; Schmitt-trigger input, 100-µA active pullup				
P0.[0:7]	43, 44, 45, 46, 47, 48, 49, 50	I/O	General-purpose I/O port 0 bits 0–7, Schmitt-trigger input, 100-μA active pullup, open-drain output [†]				
P1.[0:7]	31, 32, 33, 34, 35, 36, 40, 41	I/O	General-purpose I/O port 1 bits 0–7, Schmitt-trigger input, 100- μ A active pullup, open-drain output [†]				
P2.[0:7]	22, 23, 25, 26, 27, 28, 29, 30	I/O	General-purpose I/O port 2 bits 0–7, Schmitt-trigger input, 100-μA active pullup, open-drain output [†]				
P3.0/S0/RXD	58	I/O	P3.0: General-purpose I/O port 3 bit 0, Schmitt-trigger input, 100-µA active pullup, open-drain output [†]				
			S0: See Section 2.6.12				
			RXD: Can be used as a UART interface				
P3.1/S1/TXD	57	I/O	P3.1: General-purpose I/O port 3 bit 1, Schmitt-trigger input, 100-µA active pullup, open-drain output [†]				
		I/O	S1: See Section 2.6.12				
		I/O	TXD: Can be used as a UART interface				
P3.2	56	I/O	General-purpose I/O port 3 bit 2, Schmitt-trigger input, 100-μA active pullup, open-drain output [†] ; INTO only used internally (see Section 2.9.4)				
P3.3	55	I/O	General-purpose I/O port 3 bit 3, Schmitt-trigger input, 100-μA active pullup, open-drain output [†] ; may support INT1 input, depending on configuration (see Figure 2–5)				
P3.[4:7]	54, 53, 52, 51	I/O	General-purpose I/O port 3 bit 4, Schmitt-trigger input, 100- μ A active pullup, open-drain output [†]				
PUR	17	0	Pullup resistor connection pin (3-state); push-pull CMOS output (±8 mA)				
PWRO1	3	0	Port 1: power on/off control signal; push-pull CMOS output (±8 mA)				
PWRO2	2	0	Port 2: power on/off control signal; push-pull CMOS output (±8 mA)				
RST	13	Ι	Controller master reset signal, Schmitt-trigger input, 100-µA active pullup				
S2	8	I	General-purpose input; can be used for VID/PID selection under firmware control. This input has no internal pullup, so it must be driven/pulled either low or high and connot be left unconnected.				
S3	9	I	General-purpose input. This input has no internal pullup, so it must be driven/pulled either low or high and connot be left unconnected.				
SCL	12	0	Serial clock I ² C; push-pull output				
SDA	11	I/O	Serial data I ² C; open-drain output [†]				
SELF/BUS	21	Ι	USB power MODE select: self powered (HIGH), bus powered (LOW)				
SUSP	16	0	Suspend status signal: suspended (HIGH); unsuspended (LOW)				
TEST0 [‡]	14	I	Test input 0, Schmitt-trigger input, 100-µA active pullup				
TEST1 [‡]	15	I	Test input 1, Schmitt-trigger input, 100-μA active pullup				

[†] All open-drain output pins can sink up to 8 mA.
[‡] The functions controlled by TEST0 and TEST1 are shown in the following table. Because these two pins have internal pullups, they can be left unconnected for the default mode.

1.5 Terminal Functions (Continued)

TERMINAL		1/0	DECODIDITION					
NAME	NO.	I/O	DESCRIPTION					
VCC	10,39,62	—	Power supply input, 3.3 V typical					
VDD18 [†]	37		1.8 V. When VREN is low, 1.8 V must be applied to provide current for the core during suspend.					
VREN	38	I	Voltage regulator enable: enable active LOW; disable active HIGH					
X2	60	0	12-MHz crystal output					
X1	61	I	12-MHz crystal input					

[†] During normal operation, the internal 3.3- to 1.8-V voltage regulator of the TUSB2136 is enabled and provides power to the core. To save power during the suspend mode, the internal regulator is disabled. In this case, the pin becomes an input, and a simple external power source is required to provide power to the core. This source needs to supply a very limited amount of power (10 μA maximum) within the voltage range of 1 V to 1.95 V.

NOTE 1: The MCU treats the outputs as open-drain types in that the output can be driven low continuously, but a high output is driven for two clock cycles and then the output is placed in a high-impedance state.

TEST0	TEST1	FUNCTION			
0	0	ects 48-MHz clock input (from an oscillator or other onboard clock source)			
0	1	served for testing purposes			
1	0	erved for testing purposes			
1	1	Selects 12-MHz crystal as clock source (default)			

1.6 Revision History

Version	Date	Changes
	Dec-2000	Initial Release
A	Feb-2001	 Clarified pin descriptions for P3.2 (56), P3.3 (55), and VDDOUT (37). Add red/write capability for each of the register bits. Corrected Quiescent and Suspend current figures in Table 3.3. Added Section 4.2 Reset Timing Added NOTE to cover page.
В	Jun-2002	 Changed name of pin 37 from VDDOUT to VDD18 and enhanced pin description. Removed NOTE from cover page.
C	Apr-2003	 Simplified Terminal Function Table for GPIO Ports Clarified GPIO Port 3 pin descriptions in Terminal Function Table Clarified functional description for Pins S2 and S3 (8 & 9) Clarified TEST0 & TEST1 (14 & 15) pin functions in Terminal Functions Table Added note on open-drain output pins for Terminal Functions Table Added additional note for operation of VDD18 (pin 37) to Terminal Functions Table. Removed most references to ROM version including Fig 2.2. Added USB Logo to Cover page

2 Functional Description

2.1 MCU Memory Map

Figure 2–1 illustrates the MCU memory map under boot and normal operation. It must be noted that the internal 256 bytes of IDATA are not shown since it is assumed to be in the standard 8052 location (0000 to 00FF). The shaded areas represent the internal ROM/RAM. For more information regarding the integrated 8052, see the *TUSBxxxx Microcontroller Reference Guide* (SLLU044).

When the SDW bit = 0 (boot mode): The 6K ROM is mapped to address (0000-17FF) and is duplicated in location (8000-97FF) in code space. The internal 8K RAM is mapped to address range (0000-1FFF) in data space. Buffers, memory-mapped registers (MMRs), and I/O are mapped to address range (FD80-FFFF) in data space.

When the SDW bit = 1 (normal mode): The 6K ROM is mapped to (8000–97FF) in code space. The internal 8K RAM is mapped to address range (0000–1FFF) code space. Buffers, MMR, and I/O are mapped to address range (FD80–FFFF) in data space.

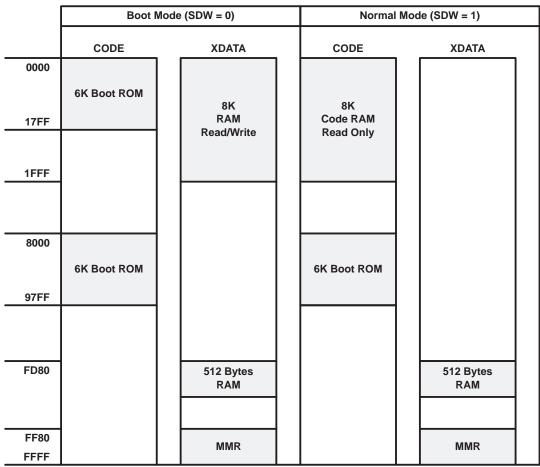


Figure 2–1. MCU Memory Map (TUSB2136B)

2.2 Miscellaneous Registers

2.2.1 TUSB2136 Boot Operation

Because the code space is in RAM (with the exception of the boot ROM), the TUSB2136 firmware must be loaded from an external source. Two options for booting are available: an external serial EEPROM source connected to the

I²C bus, or the host can be used via the USB. On device reset, the SDW bit (in the ROM register) and the CONT bit in the USB control register (USBCTL) are cleared. This configures the memory space to boot mode (see memory map, Table 2–2) and keeps the device *disconnected* from the host.

The first instruction is fetched from location 0000 (which is in the 6K ROM). The 8K RAM is mapped to XDATA space (location 0000h). The MCU executes a read from an external EEPROM and tests to see if it contains the code (test for boot signature). If it contains the code, the MCU reads from EEPROM and writes to the 8K RAM in XDATA space. If not, the MCU proceeds to boot from USB.

Once the code is loaded, the MCU sets SDW to 1. This switches the memory map to normal mode, i.e. the 8K RAM is mapped to code space, and the MCU starts executing from location 0000h. Once the switch is done, the MCU sets CONT to 1 (in the USBCTL register) This *connects* the device to the USB, resulting in the normal USB device enumeration.

2.2.2 MCNFG: MCU Configuration Register

	7	6	5	4	3	2	1	0
	RSV	XINT	OVCE	R3	R2	R1	R0	SDW
1	R/W	R/W	R/W	R/O	R/O	R/O	R/O	R/W

This register is used to control the MCU clock rate.

R/W	R/W	R/W	R/O	R/O	R/O	R/O	R/W			
BIT	NAME	RESET					FUNCTION			
0	SDW	0	This bit ena	bles/disab	les boot R	OM.				
			SDW = 0	SDW = 0 When clear, the MCU executes from the 6K boot ROM space. The boot ROM appears in two locations: 0000 and 8000h. The 8K RAM is mapped to XDATA space; therefore, read/write operation is possible. This bit is set by the MCU after the RAM load is completed. The MCU cannot clear this bit. It is cleared on power-up reset or function reset.						
			SDW = 1	SDW = 1 When set by MCU, the 6K boot ROM maps to location 8000h, and the 8K RAM is mapped to code space, starting at location 0000h. At this point, the MCU executes from RAM, and write operation is disabled (no write operation is possible in code space).						
4–1	R[3:0]	No effect	These bits	reflect the	device revi	sion numbe	er.			
5	OVCE	0	Hub overco	rrect dete	ction enable	e/disable bi	t.			
			OVCE = 0	OVCE = 0 Hub overcorrect detection is disabled.						
			OVCE = 1	OVCE = 1 Hub overcorrect detection is enabled.						
6	XINT	0	INT1 source control bit							
			XINT = 0 INT1 is connected to the P3.3 pin and operates as a standard INT1 interrupt.							
			XINT = 1	KINT = 1 INT1 is connected to the OR of port-2 inputs.						
7	RSV	0	Reserved	Reserved						

2.2.3 PUR_n: GPIO Pullup Register for Port n (n = 0 to 3)

PUR_0: GPIO pullup register for port 0 PUR_1: GPIO pullup register for port 1 PUR_2: GPIO pullup register for port 2 PUR 3: GPIO pullup register for port 3

	7	6	5	4	3	2	1	0	
PC	RT_n.7	PORT_n.6	PORT_n.5	PORT_n.4	PORT_n.3	PORT_n.2	PORT_n.1	PORT_n.0	
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
_									
E	зіт	NAME	RESET				FUNCTIO	N	

2.2.4 INTCFG: Interrupt Configuration

7	6	5	4	3	2	1	0			
RSV	RSV	RSV	RSV	13	12	11	10			
R/O	R/O	R/O	R/O	R/W	R/W	R/W	R/W			
BIT	NAME	RESET					FUNCTIO	N		
0–3	l[3:0]	0010		he MCU can write to this register to set the interrupt delay time for port 2 on the MCU. The value of the over nibble represents the delay in ms. Default after reset is 2 ms.						
4–7	RSV	0	Reserv	eserved						

2.2.5 WDCSR: Watchdog Timer, Control, and Status Register

A watchdog timer (WDT) with 1-ms clock is provided. The watchdog timer only works when a USB start-of-frame has been detected by the TUSB3210. If this register is not accessed for a period of 32 ms, the WDT counter resets the MCU (see Figure 2–2, Reset Diagram). When the IDL bit in PCON is set, the WDT is suspended until an interrupt is detected. At this point, the IDL bit is cleared and the WDT resumes operation. The WDE bit of this register is cleared only on power-up or USB reset (if enabled). When the MCU writes a 1 to the WDE bit of this register the WDT starts running.

7	6	5	4	3	2	1	0
WDE	WDR	RSV	RSV	RSV	RSV	RSV	WDT
R/W	R/W	R/O	R/O	R/O	R/O	R/O	W/O

BIT	NAME	RESET		FUNCTION				
0	WDT	0	period of 31	he MCU must write a 1 to this bit to prevent the WDT from resetting the MCU. If MCU does not write a 1 in a eriod of 31 ms, the WDT resets the device. Writing a 0 has no effect on the WDT. (The WDT is a 5-bit pounter using a 1-ms CLK). This bit is read as 0.				
5–1	RSV	0	Reserved					
6	WDR	0	Watchdog re timer reset.	Natchdog reset indication bit. This bit indicates if the reset occurred due to power-on reset or watchdog imer reset.				
			WDR = 0	A power-up or USB reset occurred.				
			WDR = 1	A watchdog time-out reset occurred. To clear this bit, the MCU must write a 1. Writing a 0 has no effect.				
7	WDE	0	Watchdog ti	mer enable				
			WDE = 0	Disabled				
			WDE = 1	Enabled				

6 5 4 3 2 1 0 7 SMOD RSV RSV RSV GF1 GF0 RSV IDL R/W R/O R/O R/O R/W R/W R/W R/O BIT NAME RESET FUNCTION 0 IDL 0 MCU idle mode bit. This bit can be set by the MCU and is cleared only by the INT1 interrupt. IDL = 0The MCU is not in idle mode. This bit is cleared by the INT1 interrupt logic when INT1 is asserted for at least 400 µs. The MCU is in idle mode and RAM is in low-power mode. The oscillator/APLL is off and the IDL = 1WDT is suspended. When in suspend mode, only INT1 can be used to exit from the idle state and generate an interrupt. INT1 must be asserted for at least 400 µs for the interrupt to be recognized. RSV Reserved 1 0 3–2 GF[1:0] 00 General-purpose bits. The MCU can write and read them. 6-4 RSV 0 Reserved 7 SMOD 0 Double baud-rate control bit. For more information see the UART serial interface in the M8052 core specification.

2.2.6 PCON: Power Control Register (at SFR 87h)

2.3 Buffers + I/O RAM Map

The address range from FD80 to FFFF is reserved for data buffers, setup packet, endpoint descriptor blocks (EDB), and all I/O. RAM space of 512 bytes [FD80–FF7F] is used for EDB and buffers. The FF80–FFFF range is used for memory-mapped registers (MMR). Table 2–1 represents the internal XDATA space allocation.

DESCRIPTION	ADDRESS RANGE	
	FFFF	
Internal memory mapped registers (MMR)	Ŷ	
	FF80	
	FF7F	
Endpoint descriptor blocks (EDB)	Ŷ	
	FF08	
	FF07	
Setup packet buffer	\uparrow	
	FF00	
	FEFF	512 -Byte
Input endpoint-0 buffer	\uparrow	RAM
	FEF8	
	FEF7	
Output endpoint-0 buffer	↑ 	
	FEF0	
	FEEF	
Data buffers (368 bytes)	↑	
	FD80	

Table 2–1. XDATA Space

ADDRESS	REGISTER	mory-Mapped Registers Summary (XDATA Range = FF80 \rightarrow FFFF) DESCRIPTION			
FFFF	FUNADR	FUNADR: Function address register			
FFFE	USBSTA	USBSTA: USB status register			
FFFD	USBMSK	USBMSK: USB interrupt mask register			
FFFC	USBCTL	USBCTL: USB control register			
FFFB	HUBVIDH	HUBVIDH: HUB-VID register (high-byte)			
FFFA	HUBVIDL	HUBVIDL: HUB-VID register (low-byte)			
FFF9	HUBPIDH	HUBPIDH: HUB-PID register (high-byte)			
FFF8	HUBPIDL	HUBPIDL: HUB-PID register (low-byte)			
FFF7	HUBCNFG	HUBCNFG: HUB-configuration register			
FFF6	VIDSTA	VIDSTA: VID/PID status register			
FFF5	HUBPOTG	HUBPOTG: HUB power-on to power-good descriptor register			
FFF4	HUBCURT	HUBCURT: HUB current descriptor register			
FFF3	I2CADR	I2CADR: I ² C address register			
FFF2	I2CDAI	I2CDAI: I ² C data-input register			
FFF1	I2CDAO	I2CDAO: I ² C data-output register			
FFF0	I2CSTA	I2CSTA: I ² C status and control register			
Ŷ	RESERVED				
FF97	PUR3	Port 3 pullup resistor register			
FF96	PUR2	Port 2 pullup resistor register			
FF95	PUR1	Port 1 pullup resistor register			
FF94	PUR0	Port 0 pullup resistor register			
FF93	WDCSR	WDCSR: Watchdog timer, control and status register			
FF92	VECINT	VECINT: Vector interrupt register			
FF91	RESERVED				
FF90	MCNFG	MCNFG: MCU configuration register			
↑	RESERVED				
FF84	INTCFG	INTCFG: Interrupt delay configuration register			
FF83	OEPBCNT_0	OEPBCNT_0: Output endpoint-0 byte count register			
FF82	OEPCNFG_0	OEPCNFG_0: Output endpoint-0 configuration register			
FF81	IEPBCNT_0	IEPBCNT_0: Input endpoint-0 byte count register			
FF80	IEPCNFG_0	IEPCNFG_0: Input endpoint-0 configuration register			

Table 2–2. Memory-Mapped Registers Summary (XDATA Range = FF80 \rightarrow FFFF)

2.4 Endpoint Descriptor Block (EDB-1 to EDB-3)

Data transfers between USB, MCU and external devices are defined by an endpoint descriptor block (EDB). Four input and four output EDBs are provided. With the exception of EDB-0 (I/O endpoint 0), all EDBs are located in SRAM as shown in Table 2–3. Each EDB contains information describing the X and Y buffers. In addition, it provides general status information.

ADDRESS	SIZE	DESCRIPTION				
FF7F						
\uparrow	22 by the	RECEDUCD				
1	32 bytes	RESERVED				
FF60						
FF5F						
\uparrow	8 bytes	Input endpoint 3: configuration				
FF58						
FF57						
↑ 	8 bytes	Input endpoint 2: configuration				
FF50 FF4F						
↑ 1	8 bytes	Input endpoint 1: configuration				
FF48	0 59100					
FF47						
^						
↑	40 bytes	RESERVED				
FF20						
FF1F						
\uparrow	8 bytes	Output endpoint 3: configuration				
FF18						
FF17						
↑ 	8 bytes	Output endpoint 2: configuration				
FF10						
FF0F ↑	8 by too	Output and point 1: configuration				
FF08	8 bytes	Output endpoint 1: configuration				
FF07						
↑ T	8 bytes	Setup packet block				
FF00						
FEFF						
\uparrow	8 bytes	Input endpoint 0: buffer				
FEF8						
FEF7						
↑ 	8 bytes	Output endpoint 0: buffer				
FEF0						
FEEF ↑		Top of buffer space				
	368 bytes	Buffers space				
	JUD Dytes	Duners space				
FD80		Start of buffer space				
ו FD80	SOO DYTES	Start of buffer space				

Table 2–3. EDB and Buffer Allocations in XDATA

Table 2–4 illustrates the EDB entries for EDB-1 to EDB-3. EDB-0 registers are described separately.

Offset	ENTRY NAME	DESCRIPTION
07	EPSIZXY_n	I/O endpoint_n: X/Y buffer size
06	EPBCTY_n	I/O endpoint_n: Y byte count
05	EPBBAY_n	I/O endpoint_n: Y buffer base address
04	SPARE	Not used
03	SPARE	Not used
02	EPBCTX_n	I/O endpoint_n: X byte count
01	EPBBAX_n	I/O endpoint_n: X buffer base address
00	EPCNF_n	I/O endpoint_n: configuration

Table 2–4. EDB Entries in RAM (n = 1 to 3)

2.4.1 **OEPCNF_n:** Output Endpoint Configuration (n = 1 to 3)

7	6	5	4	3	2	1	0
UBME	ISO	TOGLE	DBUF	STALL	USBIE	RSV	RSV
R/W	R/W	R/W	R/W	R/W	R/W	R/O	R/O

BIT	NAME	RESET		FUNCTION						
1–0	RSV	х	Reserved =	0						
2	USBIE	х	USB interru	USB interrupt enable on transaction completion. Set/clear by MCU.						
			USBIE = 0	USBIE = 0 No interrupt						
			USBIE = 1	Interrupt on transaction completion						
3	STALL	0	USB stall co	ondition indication. Set/clear by MCU.						
			STALL = 0	No stall						
			STALL = 1	USB stall condition. If set by the MCU, a STALL handshake is initiated and the bit is cleared by the MCU.						
4	DBUF	х	Double buff	Double buffer enable. Set/clear by MCU.						
			DBUF = 0	Primary buffer only (X-buffer only)						
			DBUF = 1	Toggle bit selects buffer						
5	TOGLE	х	USB toggle	bit. This bit reflects the toggle sequence bit of DATA0, DATA1						
6	ISO	х	ISO = 0	Non-isochronous transfer. This bit must be cleared by the MCU because only non-isochronous transfer is supported.						
7	UBME	х	USB buffer	manager (UBM) enable/disable bit. Set/clear by MCU.						
			UBME = 0	UBM cannot use this endpoint.						
			UBME = 1	UBM can use this endpoint.						

2.4.2 OEPBBAX_n: Output Endpoint X-Buffer Base-Address (n = 1 to 3)

7	6	5	4	3	2	1	0
A ₁₀	Ag	A ₈	A ₇	A ₆	A5	A ₄	A ₃
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

BIT	NAME	RESET	FUNCTION
7–0	A[10:3]	х	A[10:3] of X-buffer base address (padded with 3 LSB of zeros for a total of 11-bits). This value is set by the MCU. UBM or DMA uses this value as the start address of a given transaction. Furthermore, UBM or DMA does not change this value at the end of a transaction.

2.4.3 OEPBCTX_n: Output Endpoint X-Byte Count (n = 1 to 3)

7	6	5	4	3	2	1	0						
NAK	С ₆	C5	C4	C ₃	C2	C ₁	C ₀						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W						
BIT	NAME	RESET					FUNCTIO	N					
6–0	C[6:0]	x	000 00008 000 00018 : 011 1111b 100 00008	FUNCTION X-buffer byte count: $000\ 0000b \rightarrow Count = 0$ $000\ 0001b \rightarrow Count = 1\ byte$: 011\ 1111b \rightarrow Count = 63\ bytes 100\ 0000b \rightarrow Count = 64\ bytes Any value $\geq 100\ 0001b\ produces\ unpredictable\ results.$									
7	NAK	x		NAK= 0 No valid data in buffer. Ready for host out NAK= 1 Buffer contains a valid packet from host (host-out request is NAK)									

2.4.4 OEPBBAY_n: Output Endpoint Y-Buffer Base-Address (n = 1 to 3)

7	6	5	4	3	2	1	0							
A ₁₀	Ag	A ₈	A ₇	A ₆	A5	A ₄	A ₃							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W							
				FUNCTION										
BIT	NAME	RESET					FUNCTIO	N						

2.4.5 **OEPBCTY_n:** Output Endpoint Y-Byte Count (n = 1 to 3)

7	6	5	4	3	2	1	0
NAK	C ₆	C5	C ₄	C ₃	C2	C ₁	C ₀
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

BIT	NAME	RESET	FUNCTION
6–0	C[6:0]	х	Y-buffer byte count: $000\ 0000b \rightarrow Count = 0$ $000\ 0001b \rightarrow Count = 1$ byte:011\ 1111b \rightarrow Count = 63 bytes $100\ 0000b \rightarrow Count = 64$ bytesAny value $\geq 100\ 0001b$ produces unpredictable results.
7	NAK	х	NAK= 0 No valid data in buffer. Ready for host out NAK= 1 Buffer contains a valid packet from host (host-out request is NAK)

2.4.6 **OEPSIZXY_n:** Output Endpoint X-/Y-Byte Count (n = 1 to 3)

7	6	5	4	3	2	1	0	
RSV	S ₆	S5	S ₄	S ₃	S ₂	S ₁	S ₀	
R/O	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
BIT	NAME	RESET	1				FUNCTIO	N
6–0	S[6:0]	x	000 00001 000 00011 : 011 1111b 100 00001	buffer size: $p \rightarrow Count =$ $p \rightarrow Count =$ $q \rightarrow Count =$ $p \rightarrow Count =$ $p \rightarrow Count =$ $\geq 100\ 0001$	= 0 = 1 byte 63 bytes = 64 bytes	unpredictal	ble results.	
7	RSV	х	Reserved	= 0				

2.4.7 IEPCNF_n: Input Endpoint Configuration (n = 1 to 3)

7	6	5	4	3	2	1	0
UBME	ISO	TOGLE	DBUF	STALL	USBIE	RSV	RSV
R/W	R/W	R/W	R/W	R/W	R/W	R/O	R/O

BIT	NAME	RESET		FUNCTION							
1–0	RSV	х	Reserved =	0							
2	USBIE	х	USB interru	pt enable on transaction completion							
			USBIE = 0	No interrupt							
			USBIE = 1	Interrupt on transaction completion							
3	STALL	0	USB stall co	ondition indication. Set by UBM, but can be set/cleared by the MCU.							
			STALL = 0	TALL = 0 No stall							
			STALL = 1	STALL = 1 USB stall condition. If set by the MCU, a STALL handshake is initiated and the bit is cleared automatically.							
4	DBUF	х	Double buffe	er enable							
			DBUF = 0	Primary buffer only (X-buffer only)							
			DBUF = 1	Toggle bit selects buffer							
5	TOGLE	х	USB toggle	bit. This bit reflects the toggle sequence bit of DATA0, DATA1							
6	ISO	х	ISO = 0	Non-isochronous transfer. This bit must be cleared by the MCU because only non-isochronous transfer is supported.							
7	UBME	х	UBM enable	e/disable bit. Set/clear by MCU.							
			UBME = 0	UBM cannot use this endpoint.							
			UBME = 1	UBM can use this endpoint.							

2.4.8 IEPBBAX_n: Input Endpoint X-Buffer Base-Address (n = 1 to 3)

7	6	5	4	3	2	1	0	
A ₁₀	Ag	A ₈	A7	A ₆	A5	A ₄	A ₃	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

BIT	NAME	RESET	FUNCTION
7–0	A[10:3]		A[10:3] of X-buffer base address (padded with 3 LSB of zeros for a total of 11 bits). This value is set by the MCU. UBM or DMA uses this value as the start-address of a given transaction. Furthermore, UBM or DMA does not change this value at the end of a transaction.

2.4.9 IEPBCTX_n: Input Endpoint X-Byte Count (n = 1 to 3)

7	6	5	4	3	2	1	0						
NAK	С ₆	C5	C ₄	C ₃	C2	C ₁	C ₀						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W						
BIT	NAME	RESET		FUNCTION									
6–0	C[6:0]	x	000 0000k 000 0001k : 011 1111b 100 0000k	Function X-buffer byte count: $000\ 0000b \rightarrow Count = 0$ $000\ 0001b \rightarrow Count = 1$ byte $011\ 1111b \rightarrow Count = 63$ bytes $100\ 0000b \rightarrow Count = 64$ bytes Any value $\geq 100\ 0001b$ produces unpredictable results.									
7	NAK	x		NAK = 0 Buffer contains a valid packet for host-in transaction NAK = 1 Buffer is empty (host-in request is NAK)									

2.4.10 IEPBBAY_n: Input Endpoint Y-Buffer Base-Address (n = 1 to 3)

7	6	5	4	3	2	1	0							
A ₁₀	Ag	A ₈	A ₇	A ₆	A5	A ₄	A ₃							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W							
DIT				FUNCTION										
BIT	NAME	RESET					FUNCTIO	N						

2.4.11 IEPBCTY_n: Input Endpoint Y-Byte Count (n = 1 to 3)

7	6	5	4	3	2	1	0	_
NAK	С ₆	C5	C4	C ₃	C2	C ₁	C ₀	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

BIT	NAME	RESET	FUNCTION
6–0	C[6:0]	x	Y-buffer byte count: $000\ 0000b \rightarrow Count = 0$ $000\ 0001b \rightarrow Count = 1$ byte:011\ 1111b \rightarrow Count = 63 bytes $100\ 0000b \rightarrow Count = 64$ bytesAny value $\geq 100\ 0001b$ produces unpredictable results.
7	NAK	х	NAK = 0 Buffer contains a valid packet for host-in transaction NAK = 1 Buffer is empty (host-in request is NAK)

7	6	5	4	3	2	1	0	
RSV	S ₆	S ₅	S ₄	S ₃	S ₂	S ₁	S ₀	
R/O	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
BIT	NAME	RESET	1				FUNCTIO	N
6–0	S[6:0]	x	000 00000 000 00011 : 011 1111b 100 00001	buffer size: $p \rightarrow Count =$ $p \rightarrow Count =$ $\rightarrow Count =$ $p \rightarrow Count =$ $p \rightarrow Count =$ $\geq 100\ 0001$	= 0 = 1 byte 63 bytes = 64 bytes	unpredicta	ble results.	
7	RSV	х	Reserved	= 0				

2.4.12 IEPSIZXY_n: Input Endpoint X-/Y-Buffer Size (n = 1 to 3)

2.5 Endpoint-0 Descriptor Registers

Unlike EDB-1 to EDB-3, which are defined as memory entries in SRAM, endpoint-0 is described by a set of 4 registers (two for output and two for input). Table 2–5 defines the registers and their respective addresses used for EDB-0 description. EDB-0 has no *Base-Address Register*, because these addresses are hardwired to FEF8 and FEF0. Note that the bit positions have been preserved to provide consistency with EDB-n (n = 1 to 3).

ADDRESS	REGISTER NAME	DESCRIPTION	BASE ADDRESS
FF83	OEPBCNT_0	Output endpoint-0: byte-count register	
FF82	OEPCNFG_0	Output endpoint-0: configuration register	FEF0
FF81	IEPBCNT_0	Input endpoint-0: byte-count register	
FF80	IEPCNFG_0	Input endpoint-0: configuration register	FEF8

Table 2–5. Input/Output EDB-0 Registers

2.5.1 IEPCNFG_0: Input Endpoint-0 Configuration Register

7	6	5	4	3	2	1	0
UBME	RSV	TOGLE	RSV	STALL	USBIE	RSV	RSV
R/W	R/O	R/O	R/O	R/W	R/W	R/O	R/O

BIT	NAME	RESET		FUNCTION
1–0	RSV	0	Reserved =	0
2	USBIE	0	USB interru	pt enable on transaction completion. Set/clear by MCU.
			USBIE = 0	No interrupt
			USBIE = 1	Interrupt on transaction completion
3	STALL	0	USB stall co	ndition indication. Set/clear by MCU.
			STALL = 0	No stall
			STALL = 1	USB stall condition. If set by the MCU, a STALL handshake is initiated and the bit is cleared automatically by the next setup transaction.
4	RSV	0	Reserved =	0
5	TOGLE	0	USB toggle	bit. This bit reflects the toggle sequence bit of DATA0, DATA1.
6	RSV	0	Reserved =	0
7	UBME	0	UBM enable	o/disable bit. Set/clear by MCU.
			UBME = 0	UBM cannot use this endpoint.
			UBME = 1	UBM can use this endpoint.

2.5.2 IEPBCNT_0: Input Endpoint-0 Byte Count Register

7	6	5	4	3	2	1	0		
NAK	RSV	RSV	RSV	C ₃	C2	C ₁	C ₀		
R/W	R/O	R/O	R/O	R/W	R/W	R/W	R/W		
BIT	NAME	RESET					FUNCTIO	N	
3–0	C[3:0]	0000	$0000b \rightarrow 0000b \rightarrow 0000b$ $0111b \rightarrow 0000b \rightarrow 0000b$	Byte count: $0000b \rightarrow Count = 0$ $0111b \rightarrow Count = 7$ $1000b \rightarrow Count = 8$ 1001b to 1111b are reserved. (If used, defaults to 8)					
6–4	RSV	0	Reserved	= 0					
7	NAK	1				oacket for h request is f	ost-in transa NAK).	ction.	

2.5.3 **OEPCNFG_0:** Output Endpoint-0 Configuration Register

7	6	5	4	3	2	1	0	
UBME	RSV	TOGLE	RSV	STALL	USBIE	RSV	RSV	
R/W	R/O	R/O	R/O	R/W	R/W	R/O	R/O	
BIT	NAME	RESET					FUNCTIO	N
1–0	RSV	0	Reserved =	= 0				
2	USBIE	0	USB interro	upt enable	on transact	ion complet	ion. Set/clea	ar by MCU.
			USBIE = 0	No interr	upt			
			USBIE = 1	Interrupt	on transac	tion comple [.]	tion	
3	STALL	0	USB stall c	ondition in	dication. Se	et/clear by N	ICU.	
			STALL = 0	No stall				
			STALL = 1	USB stal automati		If set by the	MCU, a ST	ALL handshake is initiated and the bit is cleared
4	RSV	0	Reserved =	= 0				
5	TOGLE	0	USB toggle	e bit. This b	oit reflects th	ne toggle se	quence bit	of DATA0, DATA1.
6	RSV	0	Reserved =	= 0				
7	UBME	0	UBM enab	le/disable b	oit. Set/clea	r by MCU.		
			UBME = 0	UBM car	nnot use thi	s endpoint.		
			UBME = 1	UBM car	n use this e	ndpoint.		

7	6	5	4	3	2	1	0	
NAK	RSV	RSV	RSV	C ₃	C2	C ₁	С ₀	
R/W	R/O	R/O	R/O	R/W	R/W	R/W	R/W	
BIT	NAME	RESET					FUNCTIO	N
3–0	C[3:0]	0000	Byte cour 0000b → 0 : 0111b → 0 1000b → 0 1001b to 1	Count = 0 Count = 7 Count = 8	served. (If u	used, defau	lts to 8)	
6–4	RSV	0	Reserved	= 0				
7	NAK	1				Ready for ho acket from		AK the host).

2.5.4 OEPBCNT_0: Output Endpoint-0 Byte Count Register

2.6 USB Registers

2.6.1 FUNADR: Function Address Register

This register contains the device function address.

7	6	5	4	3	2	1	0
RSV	FA6	FA5	FA4	FA3	FA2	FA1	FA0
R/O	R/W						

BIT	NAME	RESET	FUNCTION
6–0	FA[6:0]		These bits define the current device address assigned to the function. The MCU writes a value to this register as a result of the <i>SET-ADDRESS</i> host command.
7	RSV	0	Reserved = 0

2.6.2 USBSTA: USB Status Register

All bits in this register are set by the hardware and are cleared by the MCU when writing a 1 to the proper bit location (writing a 0 has no effect). In addition, each bit can generate an interrupt if its corresponding mask bit is set (R/C notation indicates read and clear only by the MCU).

7	6	5	4	3	2	1	0	
RSTR	SUSR	RESR	PWOFF	PWON	SETUP	RSV	STPOW	
R/C	R/C	R/C	R/C	R/C	R/C	R/O	R/C	
BIT	NAME	RESET					FUNCTIO	N
0	STPOW	0	SETUP ov setup buffe		Set by hardw	are when a	setup packe	t is received while there is already a packet in the
			STPOW =	0 The M	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			STPOW =	1 SETU	P overwrite			
1	RSV	0	Reserved :	= 0				
2	SETUP	0		ETUP transaction received bit. s long as SETUP is 1, IN and OUT on endpoint-0 are NAK regardless of the value of their real NAK				
			SETUP = (D The M	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			SETUP = '	1 SETU	P transactio	n received.		
3	PWON	0		ower on request for port 3. his bit indicates if power-on to port 3 has been received. This bit generates a PWON interrupt (if ena				
			PWON = 0	The N	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			PWON = 1	Powe	r on to port 3	3 has been	received.	
4	PWOFF	0			port 3. This interrupt (if e		es whether	power-off to port 3 has been received. This bit
			PWOFF =	0 The N	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			PWOFF =	1 Powe	r off to port 3	3 has been	received.	
5	RESR	0	Function re	esume requ	uest bit			
			RESR = 0	The N	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			RESR = 1	Functi	ion resume i	s detected.		
6	SUSR	0	Function s	uspended	request bit.	This bit is s	et in respons	se to a global or selective suspend condition.
			SUSR = 0	The N	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			SUSR = 1	Funct	on suspend	is detected	ł.	
7	RSTR	0	Function re by a USB f	eset reques function res	t bit. This bit set.	is set in res	ponse to the	host initiating a port reset. This bit is not affected
			RSTR = 0	The N	ICU can clea	ar this bit b	y writing a 1.	(Writing a 0 has no effect.)
			RSTR = 1	Funct	ion reset is c	letected.		

7	6	5	4	3	2	1	0				
RSTR	SUSR	RESR	PWOFF	PWON	SETUP	RSV	STPOW				
R/W	R/W	R/W	R/W	R/W	R/W	R/O	R/W				
BIT	NAME	RESET					FUNCTIO				
0	STPOW	0	SETUP ov	erwrite inte	errupt enable	e bit					
			STPOW =	0 STPO	STPOW interrupt disabled						
			STPOW =	1 STPO	STPOW interrupt enabled						
1	RSV	0	Reserved	= 0							
2	SETUP	0	SETUP int	errupt enal	ole bit						
			SETUP = (0 SETU	P interrupt of	disabled					
			SETUP = ⁻	1 SETU	P interrupt e	enabled					
3	PWON	0	Power-on	interrupt er	errupt enable bit						
			PWON = 0) PWO	N interrupt d	lisabled					
			PWON = 1	PWO	N interrupt e	nabled					
4	PWOFF	0	Power-off i	interrupt er	rrupt enable bit						
			PWOFF =	0 PWO	PWOFF interrupt disabled						
			PWON = 1	PWO	F interrupt	enabled					
5	RESR	0			rrupt enable						
			RESR = 0		on resume						
			RESR = 1		on resume		abled				
6	SUSR	0	Function s	· · ·	errupt enabl						
			SUSR = 0	Functi	ion suspend	l interrupt d	isabled				
			SUSR = 1	Functi	ion suspend	l interrupt e	nabled				
7	RSTR	0		eset interru	pt enable						
			RSTR = 0	Functi	ion reset inte	errupt disat	bled				
			RSTR = 1	Functi	ion reset inte	errupt enab	led				

2.6.3 USBMSK: USB Interrupt Mask Register

2.6.4 USBCTL: USB Control Register

Unlike the other registers, this register is cleared by the power-up-reset signal only. The USB reset cannot reset this register (see the reset diagram in Figure 2–2).

7	6	5	4	3	2	1	0						
CONT	U1/2	RWUP	FRSTE	RWE	B/S	SIR	DIR						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_					
BIT	NAME	RESET		FUNCTION									
0	DIR	0		As a response to a setup packet, the MCU decodes the request and sets or clears this bit to reflect the data ransfer direction.									
			DIR = 0	DIR = 0 USB data OUT transaction (from host to TUSB2136)									
			DIR = 1	DIR = 1 USB data IN transaction (from TUSB2136 to host)									
1	SIR	0	SETUP int interrupt is			bit is contro	olled by the	MCU to indicate to the hardware when SETUP					
			SIR = 0	SETUP routine.	interrupt is	not served.	The MCU	clears this bit before exiting the SETUP interrupt					
			SIR = 1	SETUP	interrupt is i	in progress.	The MCU	sets this bit when servicing the SETUP interrupt.					
2	B/S	0	Bus/self po	wer contro	ol bit								
			B/S = 0	The dev	ice is bus p	owered.							
			B/S = 1	/S = 1 The device is self powered.									
3	RWE	0	Remote wa	ake-up ena	ble bit								
			RWE = 0 The MCU clears this bit when the host sends a command to clear the feature.										
			RWE = 1		U writes 1 to wake-up fea		en the host	sends set device feature command to enable the					
4	FRSTE	1	Function re	eset conne	ction bit. Th	is bit conne	cts/disconn	ects the USB function reset from the MCU reset.					
			FRSTE = 0	=0 Function reset is not connected to MCU reset.									
			FRSTE = 1	Functior	n reset is co	nnected to	MCU reset						
5	RWUP	0	Device rem	note wake-	up request.	This bit is s	et by the N	ICU and is cleared automatically.					
			RWUP = 0	Writing a	a 0 to this b	it has no eff	ect.						
			RWUP = 1	When th	e MCU writ	es a 1, a re	mote wake	-up pulse is generated.					
6	U1/2	0	USB hub v	ersion									
			U1/2 = 0 This is a USB1.x hub.										
			U1/2 = 1	This is a	uUSB2.x hu	ıb.							
7	CONT	0	Connect/di										
			CONT = 0	Upstrea	m port is dis	sconnected	Pullup dis	abled.					
			CONT = 1	Upstrea	m port is co	nnected. Pu	ullup enable	ed.					

7	6	5	4	3	2	1	0					
OCP	I/G	P3.1	P3.0	P2A	P2E	P1A	P1E					
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W					
BIT	NAME	RESET					FUNCTIO	N				
0	P1E	0	Hub port-1	ub port-1 enable/disable control bit								
			P1E = 0	Port 1 is	Port 1 is disabled.							
			P1E = 1	1 Port 1 is enabled.								
1	P1A	0	Hub port-	1; permane	nt attachme	nt control bi	t.					
			P1A = 0	Port 1 is	connected t	to a remova	ble function					
			P1A = 1	Port 1 is	connected t	to a perman	ent attachm	nent function.				
2	P2E	0	Hub port-2	lub port-2 enable/disable control bit								
			P2E = 0	Port 2 is	disabled.							
			P2E = 1	2E = 1 Port-2 is enabled.								
3	P2A	0	Hub port-2	permanen	t-attachmen	t control bit						
			P2A = 0	Port 2 is	connected t	to a remova	ble function					
			P2A = 1	Port 2 is	connected t	to a perman	ent-attachm	nent function.				
5–4	P3[1:0]	00	00b = Port 01b = Port 10b = Port	Hub port-3 embedded-function control field 00b = Port 3 is disabled (doesn't exist). 01b = Port 3 is permanently attached. 10b = Port 3 is connected to a removable function, but is not attached. 11b = Port 3 is connected to a removable function, and is attached.								
6	I/G	0	Individual/	gang powei	control bit							
			I/G = 0	Overcurr	ent and pov	ver control a	are controlle	d individually.				
			I/G = 1	Overcurr	ent and pov	ver control a	are gang co	ntrolled.				
7	OCP	0	Overcurre	nt protectio	n control bit							
			OCP = 0	Overcurr	ent protection	on is disable	ed.					
			OCP = 1	Overcurr	ent protection	on is enable	ed.					

2.6.5 HUBCNFG: Hub Configuration Register

2.6.6 HUBPOTG: Hub Power-On to Power-Good Descriptor Register

7	6	5	4	3	2	1	0		
D7	D6	D5	D4	D3	D2	D1	D0		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
BIT	NAME	RESET	FUNCTION						
7–0	D[7:0]	00h	Offset-5 in hub descriptor table						

2.6.7 HUBCURT: Hub Current Descriptor Register

7	6	5	4	3	2	1	0	
D7	D6	D5	D4	D3	D2	D1	D0	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
BIT	NAME	RESET	FUNCTION					
7–0	D[7:0]	00h	Offset-6 in hub descriptor table					

2.6.8 HUBPIDL: Hub PID Register (Low-Byte)

7	6	5	4	3	2	1	0			
D7	D6	D5	D4	D3	D2	D1	D0			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
BIT	NAME	RESET		FUNCTION						
7–0	D[7:0]	00h	Hub PID low-byte value							

2.6.9 HUBPIDH: Hub PID Register (High-Byte)

7	6	5	4	3	2	1	0		
D15	D14	D13	D12	D11	D10	D9	D8		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	-	
BIT	NAME	RESET	FUNCTION						
7–0	D[15:8]	00h	Hub PID high-byte value						

2.6.10 HUBVIDL: Hub VID Register (Low-Byte)

7	6	5	4	3	2	1	0		
D7	D6	D5	D4	D3	D2	D1	D0		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
BIT	NAME	RESET	FUNCTION						
7–0	D[7:0]	00h	Hub VID low-byte value						

2.6.11 HUBVIDH: Hub VID Register (High-Byte)

7	6	5	4	3	2	1	0		
D15	D14	D13	D12	D11	D10	D9	D8		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
BIT	NAME	RESET	FUNCTION						
7–0	D[15:8]	00h	Hub VID high-byte value						

2.6.12 VIDSTA: VID/PID Status Register

This register is used to read the value on four external pins. The firmware can use this value to select one of the vendor identification/product identifications (VID/PID) stored in memory. The TUSB2136 supports up to 16 unique VID/PIDs with application code to support different products. This provides a unique opportunity for original equipment manufacturers (OEMs) to have one device to support up to 16 different product lines by using S0–S3 to select VID/PID and behavioral application code for the selected product.

7	6	5	4	3	2	1	0
RSV	RSV	RSV	RSV	S3	S2	S1	S0
R/O							

BIT	NAME	RESET	FUNCTION
3–0	S[3:0]	х	VID/PID selection bits. These bits reflect the status of the external pins as defined by Table 2–6. Note that a pin tied low is reflected as a 0 and a pin tied high is reflected as a 1.
7–4	RSV	0	Reserved = 0

VIDSTA REGISTER	PIN		
S[3:0]	NO.	NAME	COMMENTS
SO	58	P3.0	Dual function, P3.0 I/O or S0 input
S1	57	P3.1	Dual function, P3.1 I/O or S1 input
S2	8	S2	S2-pin is input
S3	9	S3	S3-pin is input

2.7 Function Reset and Power-Up Reset Interconnect

Figure 2–2 represents the logical connection of USB-function reset ($\overline{\text{USBR}}$) and power-up reset ($\overline{\text{RST}}$) pins. The internal RESET signal is generated from the RST pin (PURS signal) or from the USB reset ($\overline{\text{USBR}}$ signal). The $\overline{\text{USBR}}$ can be enabled or disabled by the FRSTE bit in the USBCTL register (on power up FRSTE = 0). The internal RESET is used to reset all registers and logic, with the exception of the USBCTL and MISCTL registers. The USBCTL and MCU configuration registers (MCNFG) are cleared by the PURS signal only.

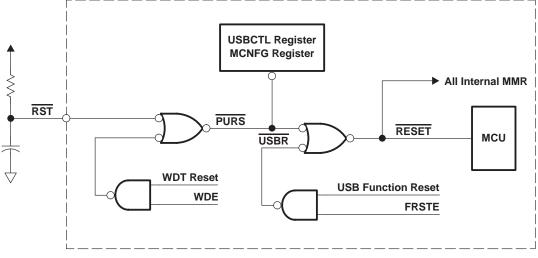


Figure 2–2. Reset Diagram

2.8 Pullup Resistor Connect/Disconnect

After reading firmware into RAM, the TUSB2136 can reenumerate using the new firmware (no need to physically disconnect and re-connect the cable). Figure 2–3 shows an equivalent circuit implementation for *Connect* and *Disconnect* from a USB upstream port (also see Figure 4–4b). When the CONT bit in the USBCTL register is 1, the CMOS driver sources VDD to the pullup resistor (PUR pin), presenting a normal connect condition to the USB hub (high speed). When the CONT bit is 0, the PUR pin is driven low. In this state, the 1.5-k Ω resistor is connected to GND, resulting in device *disconnection* state. The PUR driver is a CMOS driver that can provide VDD – 0.1 V minimum at 8-mA source current.

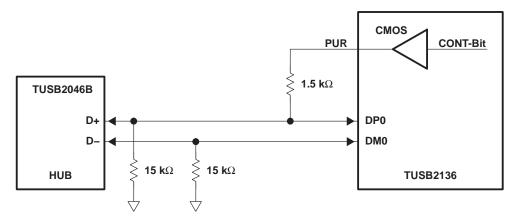


Figure 2–3. Pullup Resistor Connect/Disconnect Circuit

2.9 8052 Interrupt and Status Registers

All seven 8052-standard interrupt sources are preserved. SIE is the standard interrupt enable register, which controls the seven interrupt sources. All the additional interrupt sources are connected together as an OR to generate \overline{INTO} . The \overline{INTO} signal is provided to interrupt the MCU (see interrupt connection diagram, Figure 2–4).

INTERRUPT SOURCE	DESCRIPTION	START ADDRESS	COMMENTS
ET2	Timer-2 interrupt	002BH	
ES	UART interrupt	0023H	
ET1	Timer-1 interrupt	001BH	
EX1	Internal INT1 or INT1	0013H	Used for P2[7:0] interrupt
ET0	Timer-0 interrupt	000BH	
EX0	Internal INT0	0003H	Used for all internal peripherals
Reset		0000H	

Table 2–7. 8052 Interrupt Location Map
--

7	6	5	4	3	2	1	0			
EA	RSV	ET2	ES	ET1	EX1	ET0	INTO			
R/W	R/O	R/O	R/W	R/W	R/W	R/W	R/W			
BIT	NAME	RESET		FUNCTION						
0	INT0	0	Enable or	disable external interrupt-0						
			EX0 = 0	External	External interrupt-0 is disabled.					
			EX0 = 1	External	External interrupt-0 is enabled.					
1	ET0	0	Enable or	able or disable timer-0 interrupt						
			ET0 = 0	Timer-0 i	Timer-0 interrupt is disabled.					
			ET0 = 1	Timer-0 i	Timer-0 interrupt is enabled.					
2	EX1	0	Enable or disable external interrupt-1							
			EX1 = 0	External interrupt-1 is disabled.						
			EX1 = 1	External interrupt-1 is enabled.						
3	ET1	0	Enable or disable timer-1 interrupt							
			ET1 = 0							
			ET1 = 1							
4	ES	0	Enable or disable serial port interrupts							
			ES = 0	Serial port interrupt is disabled.						
			ES = 1	Serial port interrupt is enabled.						
5	ET2	0	Enable or disable timer-2 interrupt							
			ET2 = 0	Timer-2 interrupt is disabled.						
			ET2 = 1	Timer-2 interrupt is enabled.						
6	RSV	0		Reserved						
7	EA	0	Enable or	e or disable all interrupts (global disable)						
			EA = 0	Disable all interrupts.						
			EA = 1	Each interrupt source is individually controlled.						

2.9.1 8052 Standard Interrupt Enable Register

2.9.2 Additional Interrupt Sources

All nonstandard 8052 interrupts (USB, I²C, etc.) are connected as an OR to generate an internal INTO. It must be noted that the external INTO and INT1 are not used. Furthermore, INTO must be programmed as an active-low level interrupt (not edge-triggered). A vector interrupt register is provided to identify all interrupt sources (see vector interrupt register definition, Section 2.9.3). Up to 64 interrupt vectors are provided. It is the responsibility of the MCU to read the vector and dispatch the proper interrupt routine.

2.9.3 VECINT: Vector Interrupt Register

This register contains a vector value identifying the internal interrupt source that trapped to location 0003h. Writing any value to this register removes the vector and updates the next vector value (if another interrupt is pending). Note that the vector value is offset. Therefore, its value is in increments of two (bit 0 is set to 0). When no interrupt is pending, the vector is set to 00h. Table 2–8 is a table of the vector interrupt values. As shown, the interrupt vector is divided into two fields, I[2:0] and G[3:0]. The I-field defines the interrupt source within a group (on a first-come, first-served basis) and the G-field defines the group number. Group G0 is the lowest and G15 is the highest priority.

7	6	5	4	3	2	1	0	
G3	G2	G1	G0	12	l1	10	0	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/O	
BIT	NAME	RESET	FUNCTION					
3–1	I[2:0]	000	This field defines the interrupt source in a given group. See Table 2–8, <i>Vector Interrupt Values</i> . Bit 0 is always 0; therefore, vector values are offset by two.					
7–4	G[3:0]	0000	This field defines the interrupt group. I[2:0] and G[3:0] combine to produce the actual interrupt vector.					

Table 2–8. vector interrupt values						
G[3:0] (Hex)	l[2:0] (Hex)	VECTOR (Hex)	INTERRUPT SOURCE			
0	0	00	No interrupt			
1	0	10	RESERVED			
1	1	12	Output endpoint 1			
1	2	14	Output endpoint 2			
1	3	16	Output endpoint 3			
1	4–7	18–1E	RESERVED			
2	0	20	RESERVED			
2	1	22	Input endpoint 1			
2	2	24	Input endpoint 2			
2	3	26	Input endpoint 3			
2	4–7	28–2E	RESERVED			
3	0	30	STPOW packet received			
3	1	32	SETUP packet received			
3	2	34	PWON interrupt			
3	3	36	PWOFF interrupt			
3	4	38	RESR interrupt			
3	5	ЗA	SUSR interrupt			
3	6	3C	RSTR interrupt			
3	7	3E	RESERVED			
4	0	40	I ² C TXE interrupt			
4	1	42	I ² C RXF interrupt			
4	2	44	Input endpoint 0			
4	3	46	Output endpoint 0			
4	4–7	$48 \rightarrow 4E$	RESERVED			
5–15	Х	$90 \rightarrow FE$	RESERVED			

Table 2–8. Vector Interrupt Values

2.9.4 Logical Interrupt Connection Diagram (INT0)

Figure 2–4 represents the logical connection of the interrupt sources and the relation of the logical connection with INTO. The priority encoder generates an 8-bit vector, corresponding to 64 interrupt sources (not all are used). The interrupt priorities are hard wired. Vector 46h is the highest and 12h is the lowest. Table 2–8 lists the interrupt source for each valid interrupt vector.

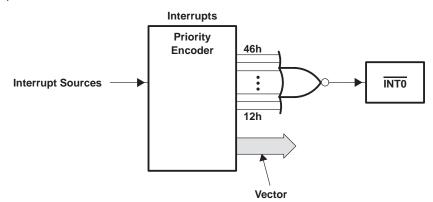


Figure 2–4. Internal Vector Interrupt (INT0)

2.9.5 P2[7:0] Interrupt (INT1)

Figure 2–5 illustrates the conceptual port-2 interrupt. All port-2 input signals are connected in a logical OR to generate the INT1 interrupt. Note that the inputs are active low and INT1 is programmed as a level-triggered interrupt. In addition, $\overline{INT1}$ is connected to the suspend/resume logic for remote wake-up support. As illustrated, the XINT bit in the MCU configuration register (MCNFG) is used to select the EX1 interrupt source. When XINT = 0, P3.3 is the source, and when XINT = 1, P2[7:0] is the source.

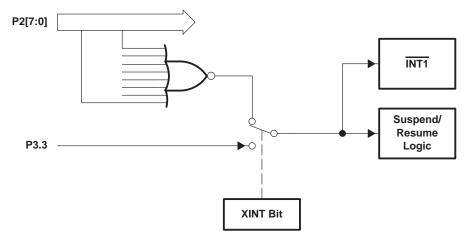


Figure 2–5. P2[7:0] Input Port Interrupt Generation

2.10 I²C Registers

The TUSB2136 only supports a master-slave relationship; therefore, it does not support bus arbitration.

2.10.1 I2CSTA: I²C Status and Control Register

This register is used to control the stop condition for read and write operations. In addition, it provides transmitter and receiver handshake signals with their respective interrupt enable bits.

7	6	5	4	3	2	1	0						
RXF	RIE	ERR	1/4	TXE	TIE	SRD	SWR	1					
R/C	R/W	R/C	R/W	R/C	R/W	R/W	R/W	ļ					
·				100	10/00	10/00							
BIT	NAME	RESET	0				FUNCTIO						
0	SWR	0	Stop write the I2CDA	write condition. This bit defines whether the I ² C controller generates a stop condition when data fro CDAO register is transmitted to an external device.									
			SWR = 0	Stop condition is not generated when data from I2CDAO register is shifted out to an externa device.									
			SWR = 1	Stop condit	ion is gener	ated when c	lata from I20	CDAO register is shifted out to an external device.					
1	SRD	0		condition. T nd loaded ir			the I ² C co	ntroller generates a stop condition when data is					
			SRD = 0	Stop condi	tion is not g	enerated w	hen data fro	m SDA line is shifted into the I2CDAI register.					
			SRD = 1	Stop condi	tion is gene	rated when	data from S	SDA line is shifted into the I2CDAI register.					
2	TIE	0	I ² C transm	itter empty	interrupt en	able							
			TIE = 0	Interrupt di	sabled								
			TIE = 1	Interrupt er	nabled								
3	TXE	1		itter empty. rate an inte		ates that da	ta can be wi	itten to the transmitter. It can be used for polling or					
			TXE = 0	Transmitte	r is full. This	bit is clear	ed when the	e MCU writes a byte to I2CDAO register.					
			TXE = 1	Transmitte copied to the	r is empty. T ne SDA shif	The I ² C cont t register.	roller sets th	nis bit when the content of the I2CDAO register is					
4	1/4	0	Bus speed	selection									
			1/4 = 0	100-kHz bi	us speed								
			1/4 = 1	400-kHz bi	us speed								
5	ERR	0	Bus error o MCU.	ondition. Th	iis bit is set	by the hard	ware when	the device does not respond. It is cleared by the					
			ERR = 0	No bus erre	or								
			ERR = 1	Bus error c	ondition has	s been dete	cted. Clears	when MCU writes a 1. Writing a 0 has no effect.					
6	RIE	0	I ² C receive	er ready inte	errupt enabl	e							
			RIE = 0	Interrupt di	sabled								
			RIE = 1	Interrupt er	nabled								
7	RXF	0	I ² C receive generate a		oit indicates	that the red	ceiver conta	ins new data. It can be used for polling or it can					
			RXF = 0	Receiver is	empty. Thi	s bit is clea	red when M	CU reads the I2CDAI register.					
			RXF = 1		ontains new d into I2CD		vit is set by th	e I ² C controller when the received serial data has					

2.10.2 I2CADR: I²C Address Register

7	6	5	4	3	2	1	0			
A ₆	A5	A ₄	A ₃	A ₂	A ₁	A ₀	R/W			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
BIT	NAME	RESET					FUNCTIO			
0	R/W	0	Read/write	Read/write command bit.						
			R/W = 0	Write ope	eration					
			R/W = 1	Read op	Read operation					
7–1	A[6:0]	0000000	Seven add	dress bits fo	r device ad	dressing				

This register holds the device address and the read/write command bit.

2.10.3 I2CDAI: I²C Data-Input Register

This register holds the received data from an external device.

7	6	5	4	3	2	1	0	
D7	D ₆	D_5	D4	D3	D_2	D ₁	D ₀]
R/O	R/O	R/O	R/O	R/O	R/O	R/O	R/O	_
BIT	NAME	RESET					FUNCTIO	DN
7–0	D[7:0]	0	8-bit input	data from a	n I ² C devid	e		

2.10.4 I2CDAO: I²C Data-Output Register

This register holds the data to be transmitted to an external device. Writing to this register starts the transfer on the SDA line.

7	6	5	4	3	2	1	0	
D7	D6	D5	D4	D3	D2	D1	D0	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
BIT	NAME	RESET					FUNCTIO	N
7–0	D[7:0]	0	8-bit outpu	it data to an	I ² C device			

2.11 Read/Write Operations

2.11.1 Read Operation (Serial EEPROM)

A serial read requires a *dummy* byte write sequence to load in the 16-bit data word address. Once the device address word and data word are clocked out and acknowledged by the device, the MCU starts a current address sequence. The following describes the sequence of events to accomplish this transaction:

Device Address + EEPROM [high byte]

- The MCU sets I2CSTA[SRD] = 0. This prevents the I²C controller from generating a stop condition after the content of the I2CDAI register is received.
- The MCU sets I2CSTA[SWR] = 0. This prevents the I²C controller from generating a stop condition after the content of the I2CDAO register is transmitted.
- The MCU writes the device address (R/W bit = 0) to the I2CADR register (write operation).
- The MCU writes the high byte of the EEPROM address into the I2CDAO register, starting the transfer on the SDA line.

- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CADR register is transmitted to the EEPROM (preceded by start condition on SDA).
- The content of the I2CDAO register is transmitted to the EEPROM (EEPROM address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been transmitted.
- No stop condition is generated.

EEPROM [low byte]

- The MCU writes the low byte of the EEPROM address into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the device (EEPROM address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been transmitted.
- This completes the *dummy* write operation. At this point, the EEPROM address is set and the MCU can perform a single or a sequential read operation.

2.11.2 Current Address Read Operation

Once the EEPROM address is set, the MCU can read a single byte by executing the following steps:

- 1. The MCU sets I2CSTA[SRD] = 1, forcing the I²C controller to generate a stop condition after the I2CDAI register is received.
- 2. The MCU writes the device address (R/W bit = 1) to the I2CADR register (read operation).
- 3. The MCU writes a dummy byte to the I2CDAO register, starting the transfer on the SDA line.
- 4. The RXF bit in I2CSTA is cleared.
- 5. The content of the I2CADR register is transmitted to the device, preceded by a start condition on SDA.
- 6. Data from the EEPROM is latched into the I2CDAI register (stop condition is transmitted).
- 7. The RXF bit in I2CSTA is set, and interrupts the MCU, indicating that the data is available.
- 8. The MCU reads the I2CDAI register. This clears the RXF bit (I2CSTA[RXF] = 0).

2.11.3 Sequential Read Operation

Once the EEPROM address is set, the MCU can execute a sequential read operation by executing the following steps (Note: this example illustrates a 32-byte sequential read):

- 1. Device Address
 - The MCU sets I2CSTA[SRD] = 0. This prevents the I²C controller from generating a stop condition after the I2CDAI register is received.
 - The MCU writes the device address (R/W bit = 1) to the I2CADR register (read operation).
 - The MCU writes a dummy byte to the I2CDAO register, starting the transfer on the SDA line.
 - The RXF bit in I2CSTA is cleared.
 - The content of the I2CADR register is transmitted to the device (preceded by a start condition on SDA).
- 2. N-Byte Read (31 bytes)
 - Data from the device is latched into the I2CDAI register (stop condition is not transmitted).

- The RXF bit in I2CSTA is set, and interrupts the MCU, indicating that data is available.
- The MCU reads the I2CDAI register, clearing the RXF bit (I2CSTA[RXF] = 0).
- This operation repeats 31 times.
- 3. Last-Byte Read (byte 32)
 - The MCU sets I2CSTA[SRD] = 1. This forces the I²C controller to generate a stop condition after the I2CDAI register is received.
 - Data from the device is latched into the I2CDAI register (stop condition is transmitted).
 - The RXF bit in I2CSTA is set, and interrupts the MCU, indicating that data is available.
 - The MCU reads the I2CDAI register, clearing the RXF bit (I2CSTA[RXF] = 0).

2.11.4 Write Operation (Serial EEPROM)

The byte write operation involves three phases: 1) device address + EEPROM [high byte] phase, 2) EEPROM [low byte] phase, and 3) EEPROM [DATA]. The following describes the sequence of events to accomplish the byte write transaction:

Device Address + EEPROM [high byte]

- The MCU sets I2CSTA[SWR] = 0. This prevents the I²C controller from generating a stop condition after the content of the I2CDAO register is transmitted.
- The MCU writes the device address (R/W bit = 0) to the I2CADR register (write operation).
- The MCU writes the high byte of the EEPROM address into the I2CDAO register, starting the transfer on the SDA line.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CADR register is transmitted to the device (preceded by a start condition on SDA).
- The content of the I2CDAO register is transmitted to the device (EEPROM high-address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been transmitted.

EEPROM [low byte]

- The MCU writes the low byte of the EEPROM address into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the device (EEPROM address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been transmitted.

EEPROM [DATA]

- The MCU sets I2CSTA[SWR] = 1. This forces the I²C controller to generate a stop condition after the content of the I2CDAO register is transmitted.
- The MCU writes the DATA to be written to the EEPROM into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the device (EEPROM data).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been transmitted.
- The I²C controller generates a stop condition after the content of the I2CDAO register is transmitted.

2.11.5 Page Write Operation

The page write operation is initiated the same way as byte write, with the exception that a stop condition is not generated after the first EEPROM [DATA] is transmitted. The following describes the sequence of writing 32 bytes in page mode:

Device Address + EEPROM [high byte]

- The MCU sets I2CSTA[SWR] = 0. This prevents the I²C controller from generating a stop condition after the content of the I2CDAO register is transmitted.
- The MCU writes the device address (R/W bit = 0) to the I2CADR register (write operation).
- The MCU writes the high byte of the EEPROM address into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CADR register is transmitted to the device (preceded by a start condition on SDA).
- The content of the I2CDAO register is transmitted to the device (EEPROM address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been sent.

EEPROM [low byte]

- The MCU writes the low byte of the EEPROM address into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the device (EEPROM address).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been sent.

31 Bytes EEPROM [DATA]

- The MCU writes the DATA to be written to the EEPROM into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the device (EEPROM data).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been sent.
- This operation repeats 31 times.

Last Byte EEPROM [DATA]

- The MCU sets I2CSTA[SWR] = 1. This forces the I²C controller to generate a stop condition after the content of the I2CDAO register is transmitted.
- The MCU writes the last DATA byte to be written to the EEPROM into the I2CDAO register.
- The TXE bit in I2CSTA is cleared, indicating busy.
- The content of the I2CDAO register is transmitted to the EEPROM (EEPROM data).
- The TXE bit in I2CSTA is set, and interrupts the MCU, indicating that the I2CDAO register has been sent.
- The I²C controller generates a stop condition after the content of the I2CDAO register is transmitted.

3 Electrical Specifications

3.1 Absolute Maximum Ratings Over Operating Free-Air Temperature Range (unless otherwise noted)[†]

Supply voltage, V _{CC}	–0.5 V to 4 V
Input voltage, V _I	–0.5 V to V _{CC} + 0.5 V
Output voltage, VO	–0.5 V to V _{CC} + 0.5 V
Input clamp current, IIK	±20 mA
Output clamp current, I _{OK}	±20 mA
Storage temperature	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

3.2 Commercial Operating Conditions

	PARAMETER	MIN	NOM	MAX	UNIT
VCC	Supply voltage	3	3.3	3.6	V
VI	Input voltage	0		VCC	V
VIH	High-level input voltage	2		VCC	V
V_{IL}	Low-level input voltage	0		0.8	V
TA	Operating temperature	0		70	°C

3.3 Electrical Characteristics, T_{A} = 25°C, V_{CC} = 3.3 V \pm 0.3 V, GND = 0 V

	PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT
VOH	High-level output voltage	$I_{OH} = -4 \text{ mA}$	V _{CC} -0.5			V
VOL	Low-level output voltage	$I_{OL} = 4 \text{ mA}$			0.5	V
V _{IT+}	Positive input threshold voltage	$V_I = V_{IH}$			2	V
V _{IT} –	Negative input threshold voltage	$V_{I} = V_{IL}$	0.8			V
V _{hys}	Hysteresis (V _{IT+} – V _{IT} _)	$V_I = V_{IH}$		1		V
ΙΗ	High-level input current	$V_I = V_{IH}$			±1	μΑ
١	Low-level input current	$V_I = V_{IL}$			±1	μΑ
loz	Output leakage current (Hi-Z)	$V_I = V_{CC} \text{ or } V_{SS}$			10	μΑ
Cl	Input capacitance			5		pF
CO	Output capacitance			7		pF
ICC	Quiescent			25	45	mA
ICCX	Suspend			45		μΑ
I _{CCx} 1.8	Suspend 1.8 VDD				1	μA

4 Application

4.1 Keyboard Section

Table 4–1 outlines the GPIO assignment for the switch-matrix scanning and for keyboard LED drive. Figure 4–1 illustrates the port-3 pins that are assigned to drive the four keyboard LEDs. As shown, P3[5:2] can sink up to 12 mA (open-drain output) on each pin. Figure 4–2 illustrates the 18 outputs (open-drain) and the 8 inputs (internal pullups) that are used for the switch-matrix scanning. Figure 4–3 illustrates the partial connection bus power mode. Figure 4–4 shows the USB upstream connection, and Figure 4–5 illustrates the downstream connection (only one port shown).

GPIO	I/O	
P0[7:0]	0	8-bit matrix-scan outputs
P1[7:0]	0	8-bit matrix-scan outputs
P3.6	0	1-bit matrix-scan output
P3.7	0	1-bit matrix-scan output
P2[7:0]	I	8-bit matrix-scan inputs
P3.2	0	Keyboard LED-1
P3.3	0	Keyboard LED-2
P3.4	0	Keyboard LED-3
P3.5	0	Keyboard LED-4
P3.0	I/O	GPIO (Not used for keyboard)
P3.1	I/O	GPIO (Not used for keyboard)

Table 4–1. GPIO Assignment for Matrix Scan and LED Drive

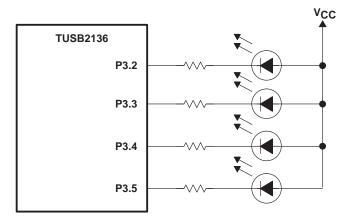


Figure 4–1. Keyboard LED Connection

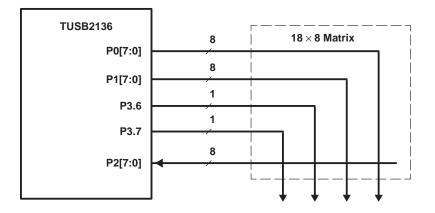


Figure 4–2. Keyboard Matrix Scan Connection

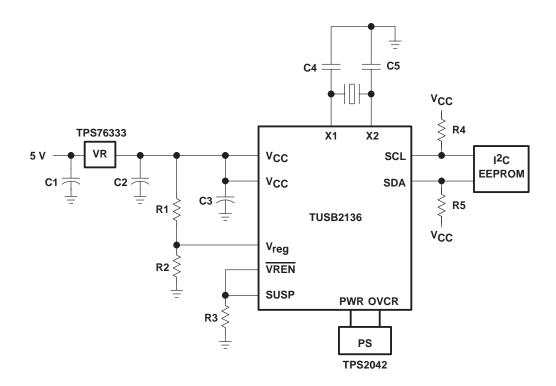


Figure 4–3. Partial Connection Bus Power Mode

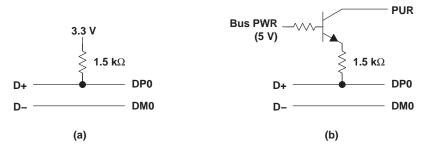


Figure 4–4. Upstream Connection (a) Non-Switching Power Mode (b) Switching Power Mode

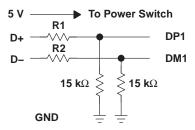
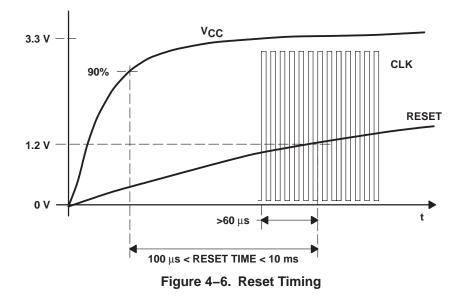


Figure 4–5. Downstream Connection – Only One Port Shown

4.2 Reset Timing

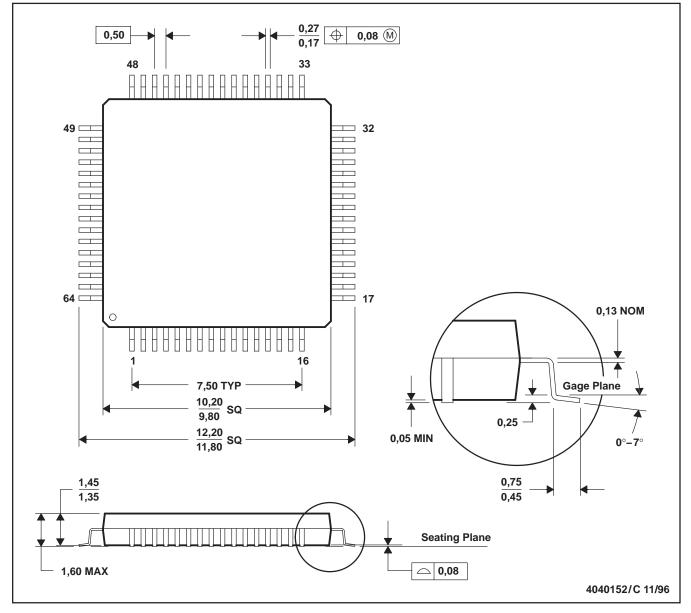
There are two requirements for the reset signal timing. First, the reset window should be between 100 μ s and 10 ms. At power up, this time is measured from the time the power ramps up to 90% of the nominal V_{CC} until the reset signal goes high (above 1.2 V). The second requirement is that the clock has to be valid during the last 60 μ s of the reset window. These two requirements are depicted in Figure 4–6. Notice that when using a 12-MHz crystal or the 48-MHz oscillator, the clock signal may take several milliseconds to ramp up and become valid after power up. Therefore, the reset window may need to be elongated up to 10 ms to ensure that there is a 60- μ s overlap with a valid clock.



5 Mechanical Data

PM (S-PQFP-G64)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Falls within JEDEC MS-026
- D. May also be thermally enhanced plastic with leads connected to the die pads.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins I	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TUSB2136PM	ACTIVE	LQFP	PM	64	160	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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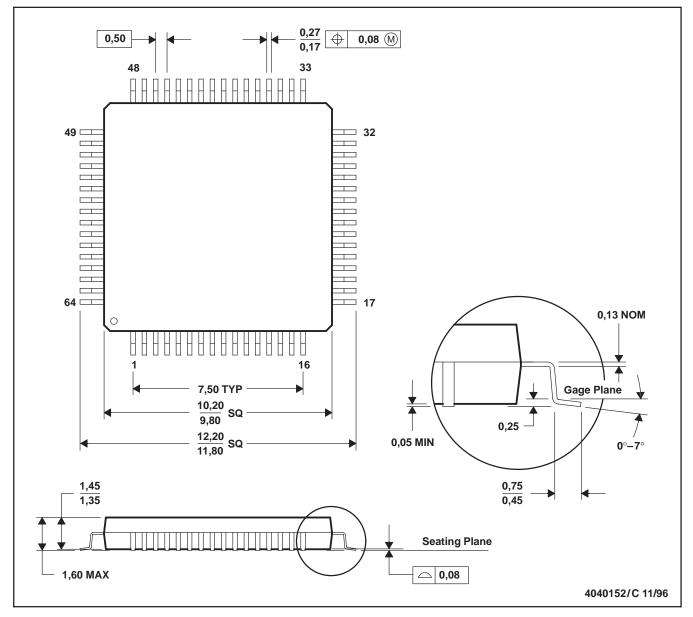
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MECHANICAL DATA

MTQF008A - JANUARY 1995 - REVISED DECEMBER 1996

PM (S-PQFP-G64)

PLASTIC QUAD FLATPACK



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